

Link do produktu: <https://serwisowe.pl/uniwersalny-podgrzewacz-serwisowy-bga-cpu-maant-sl-1-usb-c-p-13303.html>

UNIWERSALNY PODGRZEWACZ SERWISOWY BGA CPU MAANT SL-1 USB- C

Cena brutto	108,46 zł
Cena netto	88,18 zł
Dostępność	Aktualnie niedostępny
Czas wysyłki	24 godziny
Numer katalogowy	XSLU0000954
Kod EAN	6949639143921

Opis produktu

SLU0000954

UNIWERSALNY PODGRZEWACZ SERWISOWY BGA CPU MaANT SL-1 USB-C



Podgrzewacz **MaAnt SL-1** służy m.in do szybkiego podgrzewania małych układów BGA o wielkości do 18,5x20mm.

Urządzenie posiada skokową regulację temperatury w zakresie od 160 do 250°C.

W skład zestawu wchodzi:

- podgrzewacz MaAnt SL-1,
- zapasowa płytki dociskające.

Aluminiowa płyta grzewcza rozgrzewa się bardzo szybko do zadanej temperatury. Czas osiągnięcia 250C to ok 60sek.

Magic furnace to remove glue



High temperature clamp



Dane techniczne:

- **model:** MaAnt SL01
- **moc:** ok. 20W,
- **płyta grzewcza:** 18,5x20mm,
- **zakres temperatury:** 0-160C,
- **zasilanie:** port USB-C
- wskaźnik zasilania: tak dioda LED
- wysokość: 17mm,
- długość: 70mm,
- szerokość: 60mm,
- waga: 65g.

LOW VOLTAGE HEATING BOARD

Non-traditional 220v high pressure heating

Fast heating, no leakage, no static electricity, safer
Curve heating, built-in professional adjustment curve, no
need to worry Chip damage caused by thermal stress



PRODUCT PACKAGING INFORMATION

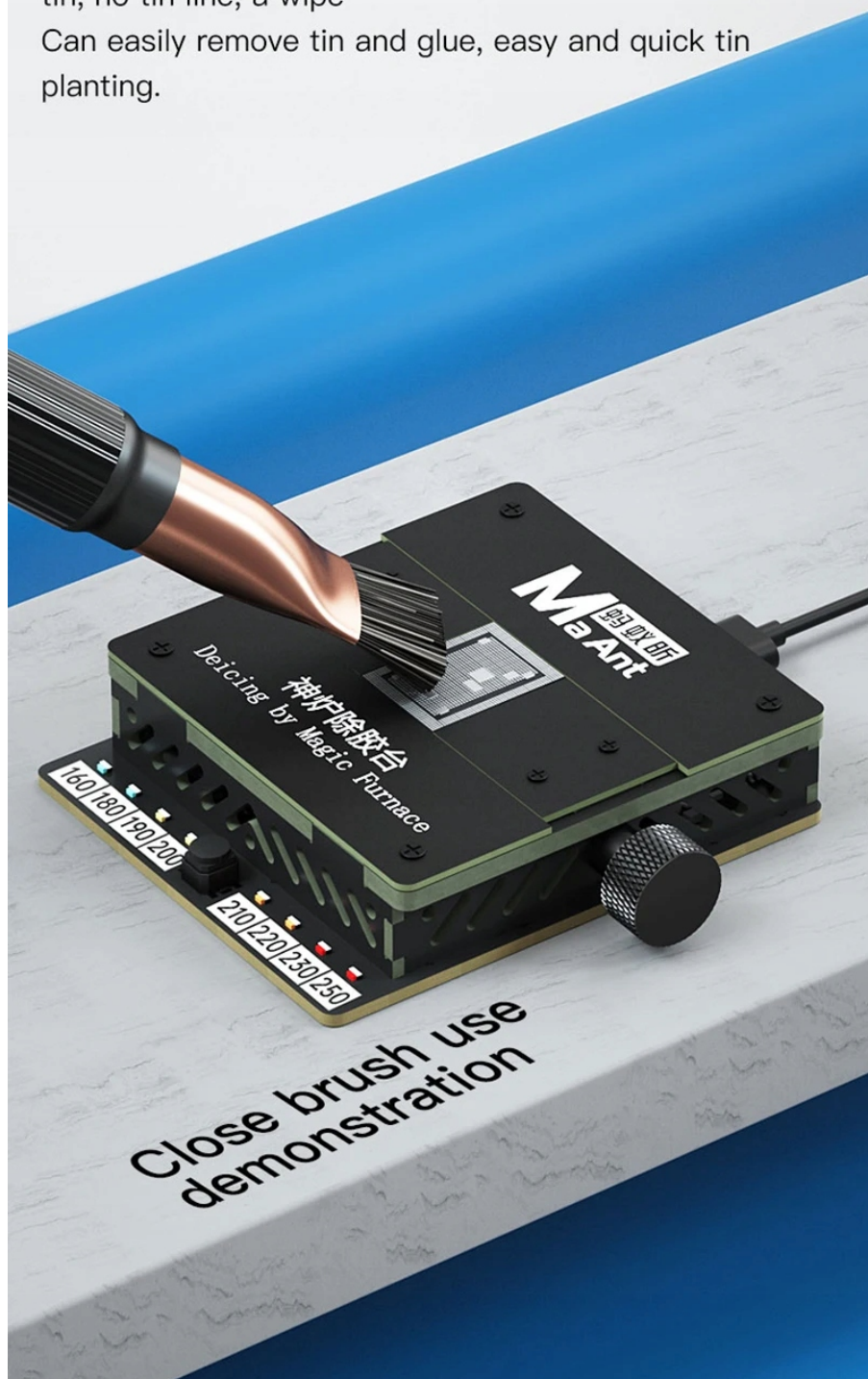
Net weight: 65g Gross weight: 75g

Product size: 70*60*17mm Package size: 77*78*20mm



Easy tin removal

After opening the glue removal table and heating to the set temperature, you can use ant Xin Brush or cotton ball and cotton swab to remove residual tin, no tin line, a wipe
Can easily remove tin and glue, easy and quick tin planting.





Widely used

Compatible with chips below 20mm x 18.5mm

Applies to 99% of the chips on the market

20mm x 18.5mm working area, supports multiple generations
Pingguo mobile phone chip, Huawei mobile phone chip universal
hard disk and CPU Glue detinning





The rubber removal table of
the magic furnace

Compatible with chips below 20mm x 18.5mm

CONSTANT TEMPERA TURE HEATING Gumming table

Adjustable
temperature **160°C~250°C**

One-button heating, rapid heating, temperature can be
adjusted 160-250°C. Support multi-generation Pingguo,
Huawei chip glue removal, tin removal work



160°C~250°C

CONSTANT TEMPERATURE HEATING REMOVES GLUE AND TIN

When heating, the temperature can be adjusted
between 160° and 250°

Effectively avoid due to high temperature or
improper training Burn-out chip





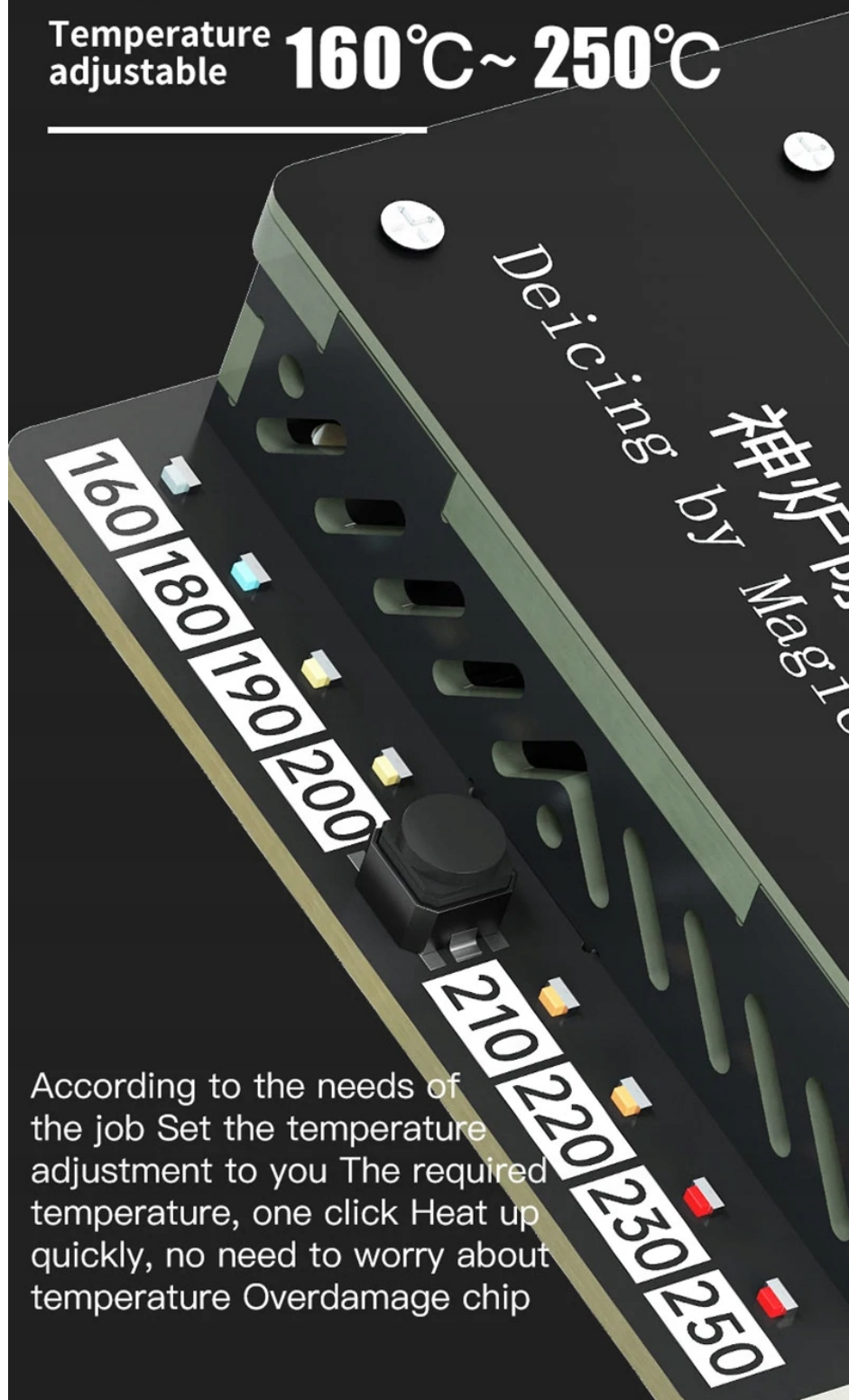
NON-ABSORBING TIN TAPE

After heating to a set temperature, use a cotton swab
Can handle clean residual tin without damage to pad
paint Non-absorbent tin brings back the wipe that wears
the chip for a long time



Temperature adjustable

Temperature adjustable **160°C ~ 250°C**



According to the needs of the job Set the temperature adjustment to you The required temperature, one click Heat up quickly, no need to worry about temperature Overdamage chip

Fast charger power supply Heating operation

Fast charger support heating work, work want
Do it right where you are, anytime, anywhere
professional



Where are the people Where is the workbench

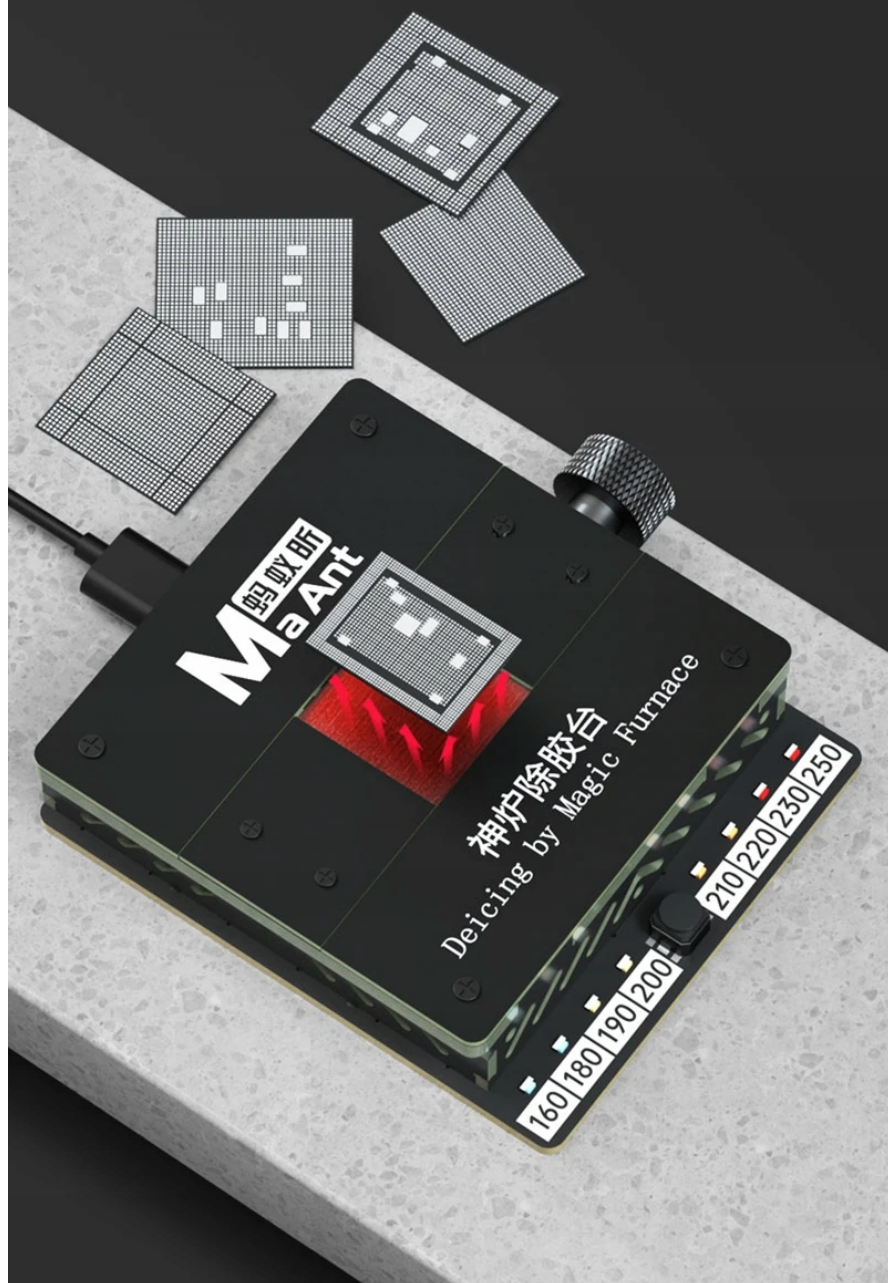
Power fast charge PD, QC
Support heating



Air-free gun heating No soldering iron heating

Air gun heating is safer than 100 degrees lower
than air gun temperature scraping

No soldering iron heating without repeated
scraping of soldering iron, no damage to the pad



Product information parameter



brand: MA ANT name: The rubber removal table of the magic furnace

Model number: SL-1 temperature: 160°C~250°C

apply: Applicable to 99% chips on the market, all kinds of common Pingguo, Huawei, CPU glue removal

Net weight: 65g Gross weight: 75g

Product size: 70*60*17mm Package size: 77*78*20mm



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Potrzebujesz akcesoria serwisowe bądź lutownicze - zapraszamy na nasze pozostałe aukcje.